

plerow[™] ALN0832

Internally Matched LNA Module

Features

- · S₂₁ = 29.1 dB @ 830 MHz = 28.9 dB @ 835 MHz
- · NF of 0.7 dB over Frequency
- · Unconditionally Stable
- · Single 5V Supply
- · High OIP3 @ Low Current

Description

The plerow[™] ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.





Specifications (in Production)

Typ. @ T = 25°C, V_s = 5 V, Freq. = 832.5 MHz, Z_{o.sys} = 50 ohm Specifications Parameter Unit Min Typ Max **Frequency Range** MHz 830 835 Gain dB 28 29 Gain Flatness dB ± 0.1 ± 0.2 Noise Figure dB 0.70 0.75 Output IP3⁽¹⁾ dBm 31 32 S11 / S22 (2) dB -15 / -15 Output P1dB dBm 16 17 Switching Time (3) μsec _ Supply Current mΑ 130 150 Supply Voltage V 5 Impedance Ω 50 Max. RF Input Power C.W 29 ~ 31 (before fail) dBm Package Type & Size mm Surface Mount Type, 13Wx13Lx3.8H



2-stage Single Type

More Information

Website: www.asb.co.kr E-mail: sales@asb.co.kr

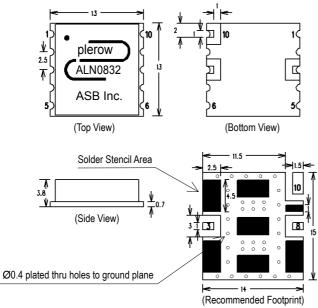
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ASB Inc., 4th Fl. Venture Town Bldg., 367-17 Goijeong-Dong, Seo-Gu, Daejon 302-716, Korea

Operating temperature is -40°C to +85°C.

1) OIP3 is measured with two tones at an output power of 0 dBm / tone separated by 1 MHz.
2) S11/S22 (max) is the worst value within the frequency band.
3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V_S.

Outline Drawing (Unit: mm)



Pin Number	Function
3	RF In
8	RF Out
10	+Vcc
Others	Ground

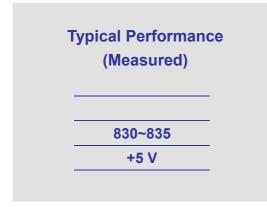
Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.

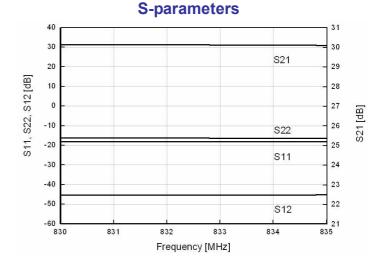
2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.



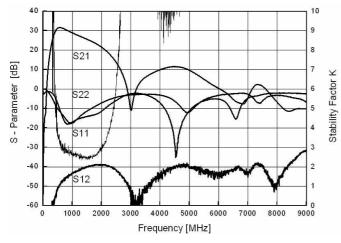
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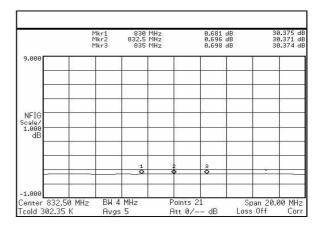




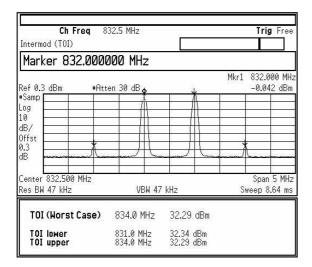
S-parameters & K Factor



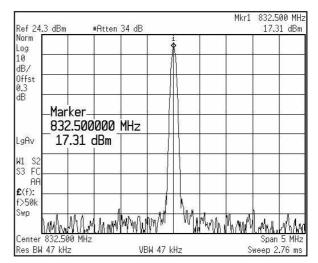
Noise Figure



OIP3



P1dB





Item Voltage	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
4.5	-15.11	-18.16	28.98	0.01	0.695	14.12	27.08	99
4.6	-15.33	-17.72	29.10	0.01	0.699	14.99	28.55	105
4.7	-15.52	-17.38	29.20	0.01	0.705	15.62	29.26	110
4.8	-15.69	-17.01	29.29	0.01	0.704	16.04	30.25	115
4.9	-15.77	-16.83	29.38	0.01	0.692	16.80	30.91	119
5.0	-15.92	-16.54	29.46	0.01	0.693	17.28	32.17	124
5.1	-16.09	-16.21	29.54	0.01	0.705	17.70	32.79	132
5.2	-16.20	-16.02	29.60	0.01	0.709	18.18	33.51	137
5.3	-16.31	-15.86	29.66	0.01	0.709	18.62	34.05	143
5.4	-16.36	-15.66	29.71	0.01	0.709	18.93	34.54	149
5.5	-16.44	-15.50	29.76	0.01	0.713	19.27	35.40	154

RF Performance with Voltage Change

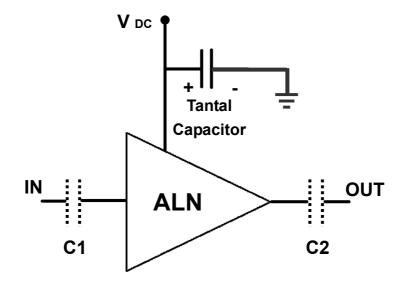
RF Performance with Operating Temperature

ltem Temp.	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
- 40°C	-15.85	-14.94	29.86	0.01	0.491	17.16	32.36	117
- 20°C	-16.18	-15.44	29.76	0.01	0.544	17.32	32.36	122
0°C	-16.12	-15.90	29.62	0.01	0.609	17.43	32.25	124
25°C	-16.03	-16.53	29.43	0.01	0.692	17.41	32.10	126
40°C	-15.77	-16.88	29.33	0.01	0.741	17.48	32.06	127
60°C	-15.50	-17.30	29.24	0.01	0.812	17.52	32.02	128
80°C	-15.03	-17.76	29.10	0.01	0.888	17.60	31.93	130
100°C	-14.70	-18.48	28.95	0.01	1.001	17.65	31.95	130



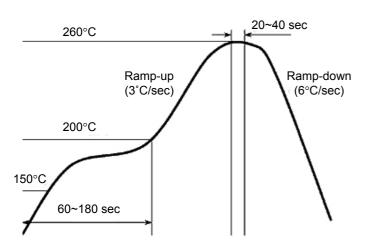
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Application Circuit

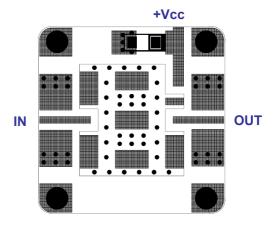


- The tantal capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status.
- 2) So-called DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the LNA module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

Recommended Soldering Reflow Process



Evaluation Board Layout



Size 25 x 25mm (for ALN Series – 13x13mm)